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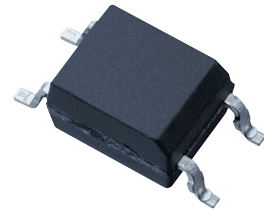
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# PC365N Series

Mini-flat Package,  
Darlington Phototransistor Output,  
Low Input Current Photocoupler



## ■ Description

**PC365N** contains an IRED optically coupled to a phototransistor.

It is packaged in a 4-pin Mini-flat.

Low input current type.

Input-output isolation voltage(rms) is 3.75kV.

CTR is MIN. 600% at input current of 0.5mA.

## ■ Features

1. 4-pin Mini-flat package
2. Double transfer mold package (Ideal for Flow Soldering)
3. Low input current type ( $I_F=0.5\text{mA}$ )
4. Darlington phototransistor output (CTR : MIN. 600% at  $I_F=0.5\text{mA}$ ,  $V_{CE}=2\text{V}$ )
5. High isolation voltage between input and output ( $V_{\text{iso(rms)}} : 3.75\text{kV}$ )

## ■ Agency approvals/Compliance

1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. **PC365**)
2. Package resin : UL flammability grade (94V-0)

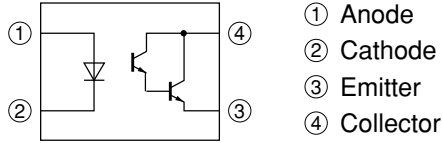
## ■ Applications

1. Programmable controllers
2. Facsimiles
3. Telephones

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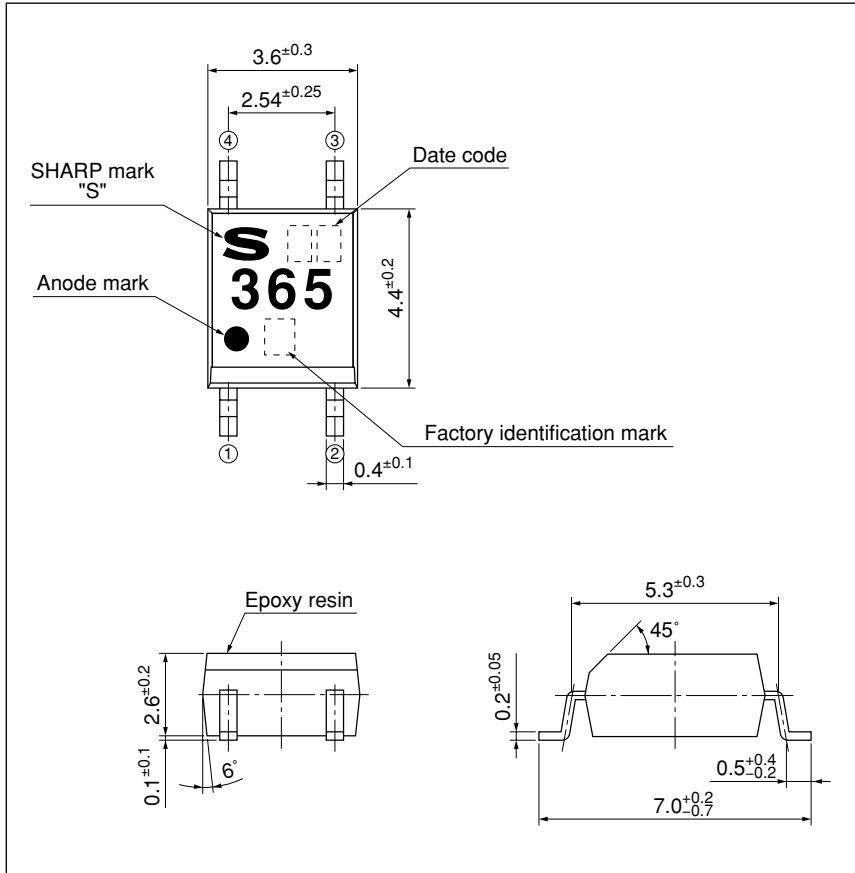
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## Internal Connection Diagram



## Outline Dimensions

(Unit : mm)







## Date code (2 digit)

1st digit				2nd digit	
Year of production				Month of production	
A.D.	Mark	A.D.	Mark	Month	Mark
1990	A	2002	P	January	1
1991	B	2003	R	February	2
1992	C	2004	S	March	3
1993	D	2005	T	April	4
1994	E	2006	U	May	5
1995	F	2007	V	June	6
1996	H	2008	W	July	7
1997	J	2009	X	August	8
1998	K	2010	A	September	9
1999	L	2011	B	October	O
2000	M	2012	C	November	N
2001	N	∴	∴	December	D

repeats in a 20 year cycle

## Factory identification mark

Factory identification Mark	Country of origin
no mark	Japan
	
	Indonesia
	Philippines
	China

\* This factory marking is for identification purpose only.  
Please contact the local SHARP sales representative to see the actual status of the production.

## ■ Absolute Maximum Ratings (T<sub>a</sub>=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	10	mA
	*1 Peak forward current	I <sub>FM</sub>	200	mA
	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation	P	15	mW
Output	Collector-emitter voltage	V <sub>CEO</sub>	35	V
	Emitter-collector voltage	V <sub>ECO</sub>	6	V
	Collector current	I <sub>C</sub>	80	mA
	Collector power dissipation	P <sub>C</sub>	150	mW
	Total power dissipation	P <sub>tot</sub>	170	mW
	*2 Isolation voltage	V <sub>iso (rms)</sub>	3.75	kV
	Operating temperature	T <sub>opr</sub>	-30 to +100	°C
	Storage temperature	T <sub>stg</sub>	-40 to +125	°C
	*3 Soldering temperature	T <sub>sol</sub>	260	°C

\*1 Pulse width ≤ 100μs, Duty ratio : 0.001

\*2 40 to 60%RH, AC for 1 minute, f=60Hz

\*3 For 10s

## ■ Electro-optical Characteristics (T<sub>a</sub>=25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =5mA	-	1.2	1.4	V	
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =4V	-	-	10	μA	
	Terminal capacitance	C <sub>t</sub>	V=0, f=1kHz	-	30	250	pF	
Output	Collector dark current	I <sub>CEO</sub>	V <sub>CE</sub> =10V, I <sub>F</sub> =0	-	-	1000	nA	
	Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> =0.1mA, I <sub>F</sub> =0	35	-	-	V	
	Emitter-collector breakdown voltage	BV <sub>ECO</sub>	I <sub>E</sub> =10μA, I <sub>F</sub> =0	6	-	-	V	
Transfer characteristics	Collector current	I <sub>C</sub>	I <sub>F</sub> =0.5mA, V <sub>CE</sub> =2V	3	14	60	mA	
	Collector-emitter saturation voltage	V <sub>CE (sat)</sub>	I <sub>F</sub> =1mA, I <sub>C</sub> =2mA	-	-	1.0	V	
	Isolation resistance	R <sub>ISO</sub>	DC500V, 40 to 60%RH	5×10 <sup>10</sup>	1×10 <sup>11</sup>	-	Ω	
	Floating capacitance	C <sub>f</sub>	V=0, f=1MHz	-	0.6	1.0	pF	
	Response time	Rise time	t <sub>r</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =10mA, R <sub>L</sub> =100Ω	-	60	300	μs
		Fall time	t <sub>f</sub>		-	53	250	μs

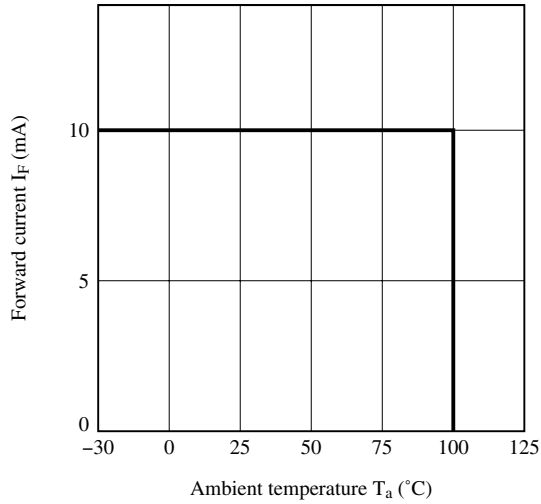
**■ Model Line-up**

Package	Taping	
	3 000 pcs/reel	750 pcs/reel
Model No.	<b>PC365N</b>	<b>PC365NT</b>

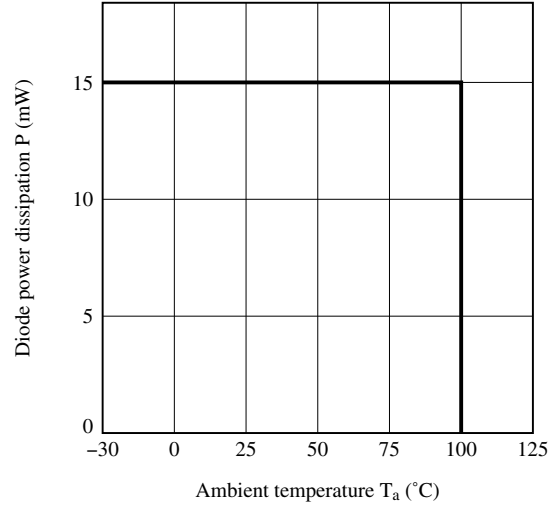
Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.



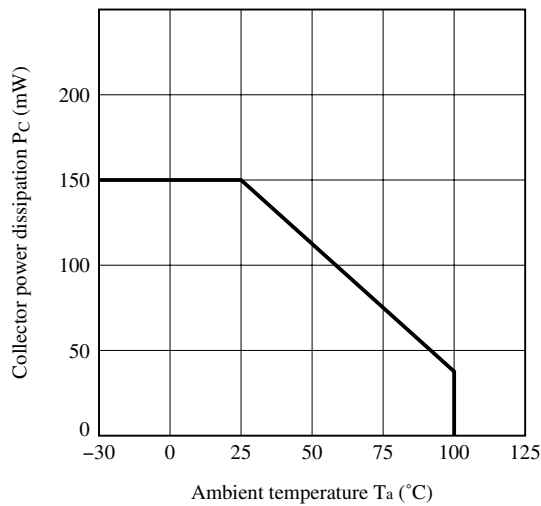
**Fig.1 Forward Current vs. Ambient Temperature**



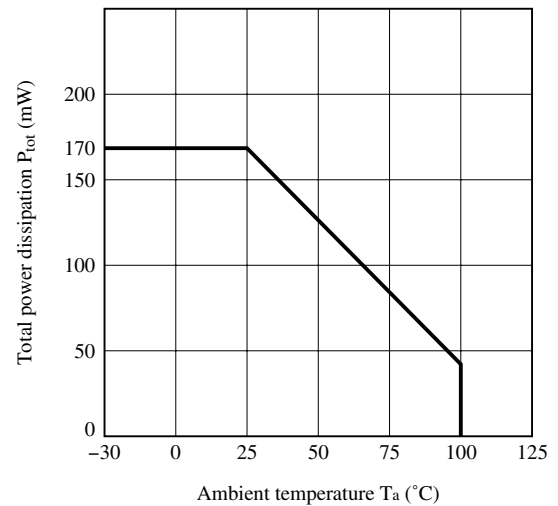
**Fig.2 Diode Power Dissipation vs. Ambient Temperature**



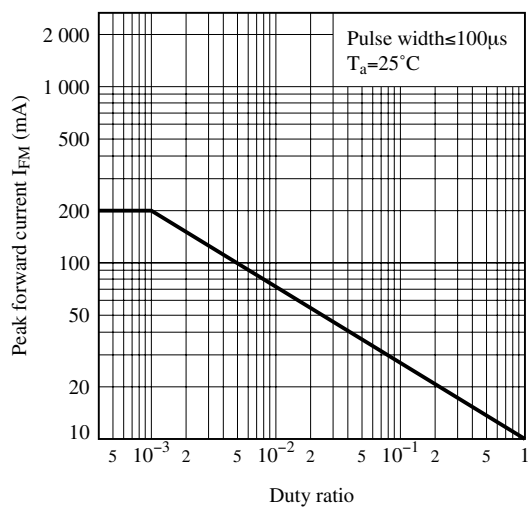
**Fig.3 Collector Power Dissipation vs. Ambient Temperature**



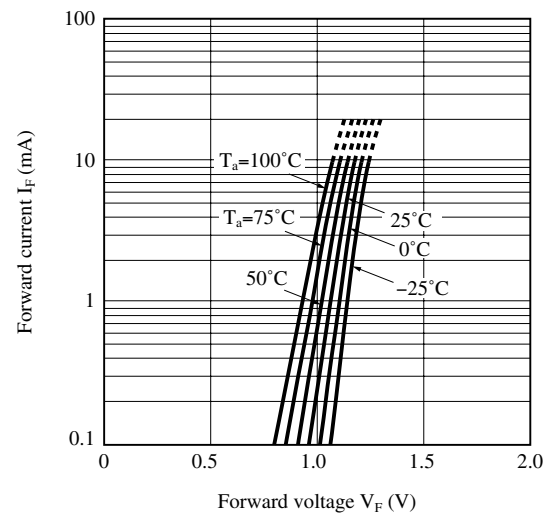
**Fig.4 Total Power Dissipation vs. Ambient Temperature**



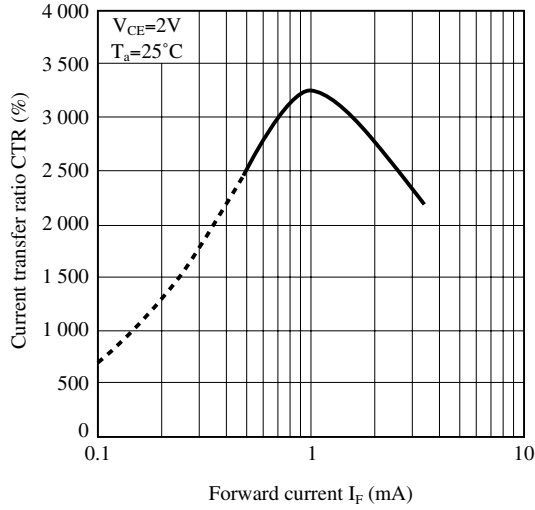
**Fig.5 Peak Forward Current vs. Duty Ratio**



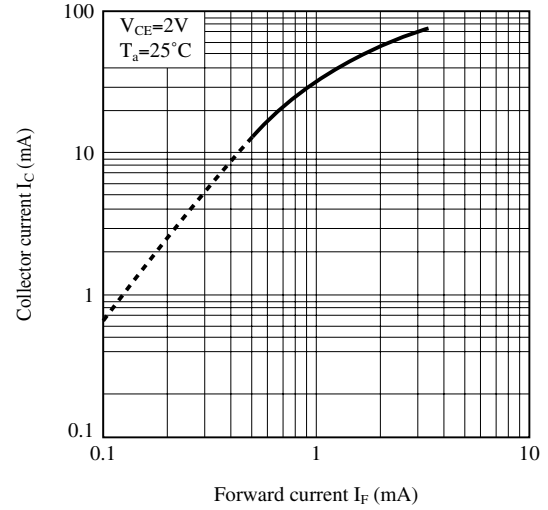
**Fig.6 Forward Current vs. Forward Voltage**



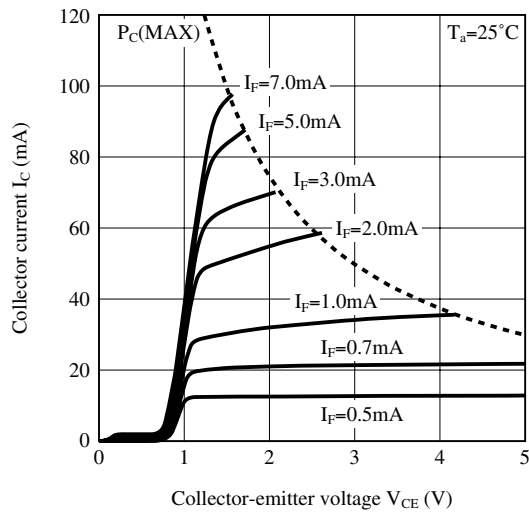
**Fig.7 Current Transfer Ratio vs. Forward Current**



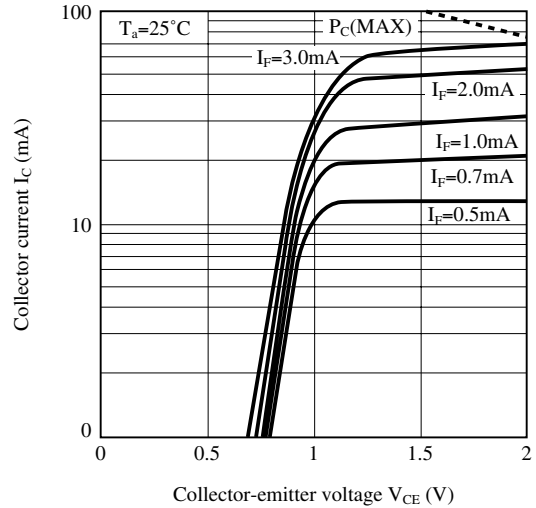
**Fig.8 Collector Current vs. Forward Current**



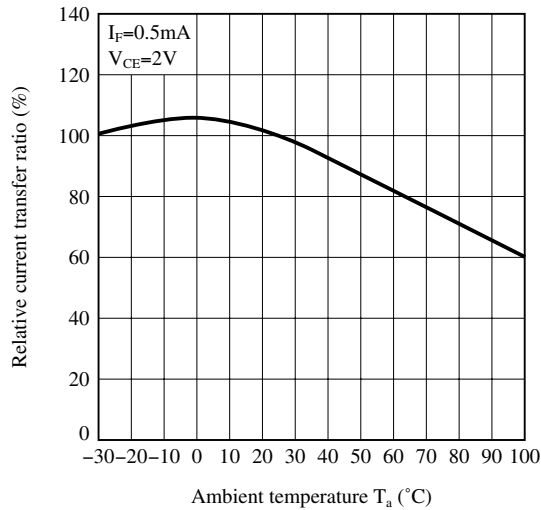
**Fig.9 Collector Current vs. Collector-emitter Voltage (1)**



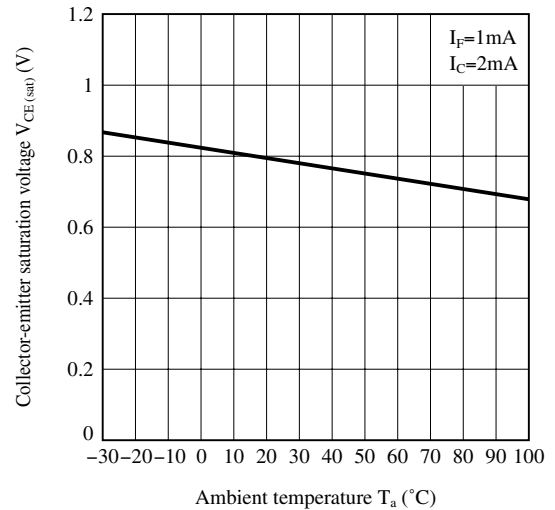
**Fig.10 Collector Current vs. Collector-emitter Voltage (2)**



**Fig.11 Relative Current Transfer Ratio vs. Ambient Temperature**

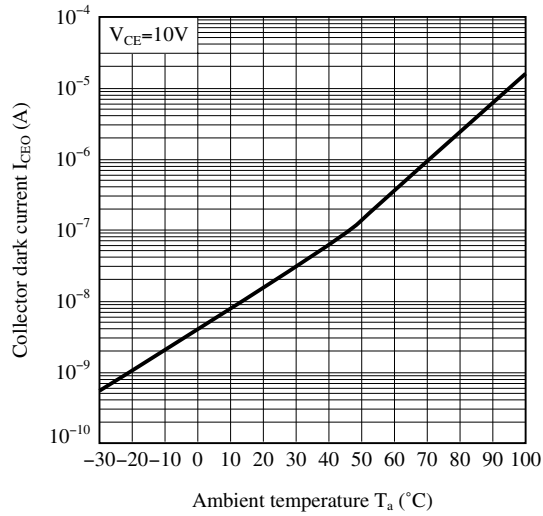


**Fig.12 Collector - emitter Saturation Voltage vs. Ambient Temperature**

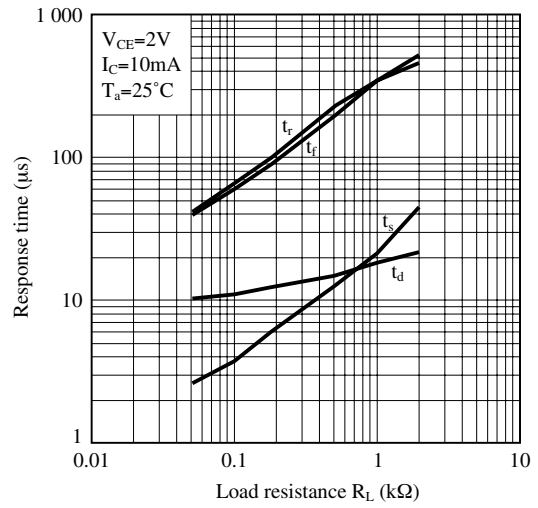




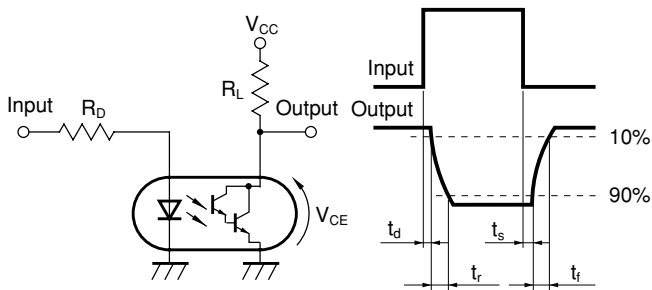
**Fig.13 Collector Dark Current vs. Ambient Temperature**



**Fig.14 Response Time vs. Load Resistance**



**Fig.15 Test Circuit for Response Time**



Please refer to the conditions in Fig.14

Remarks : Please be aware that all data in the graph are just for reference and not for guarantee.



## ■ Manufacturing Guidelines

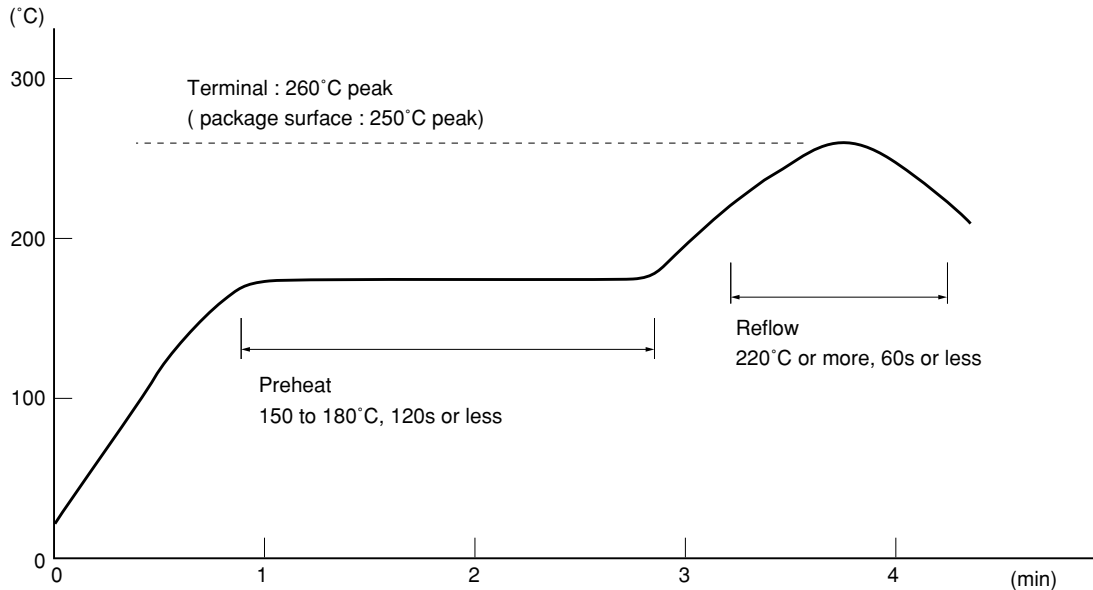
### ● Soldering Method

#### Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



#### Flow Soldering :

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

#### Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

#### Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.

**● Cleaning instructions****Solvent cleaning:**

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

**Ultrasonic cleaning:**

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

**Recommended solvent materials:**

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

**● Presence of ODC**

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances:CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

## ■ Package specification

### ● Tape and Reel package

1. 3 000pcs/reel

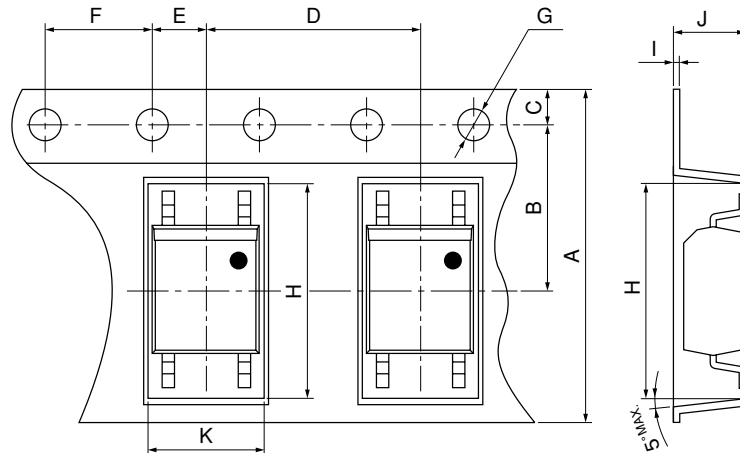
Package materials

Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

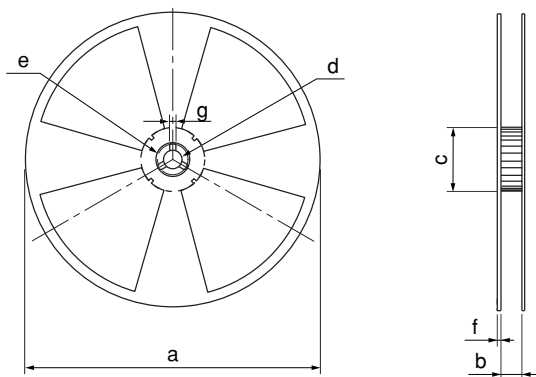
Reel : PS

Carrier tape structure and Dimensions



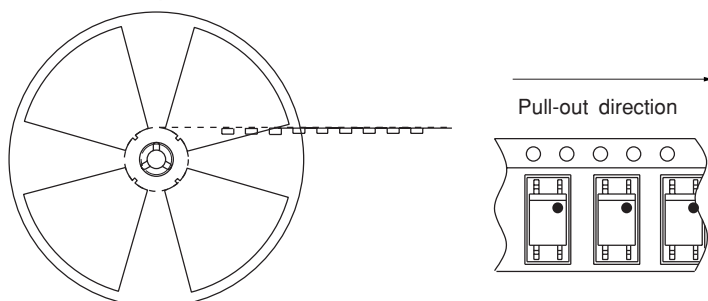
Dimensions List (Unit : mm)						
A	B	C	D	E	F	G
12.0 $\pm$ 0.3	5.5 $\pm$ 0.1	1.75 $\pm$ 0.1	8.0 $\pm$ 0.1	2.0 $\pm$ 0.1	4.0 $\pm$ 0.1	$\phi$ 1.5 $\pm$ 0.1
H	I	J	K			
7.4 $\pm$ 0.1	0.3 $\pm$ 0.05	3.1 $\pm$ 0.1	4.0 $\pm$ 0.1			

### Reel structure and Dimensions



Dimensions List (Unit : mm)			
a	b	c	d
370	13.5 $\pm$ 1.5	80 $\pm$ 1.0	13 $\pm$ 0.5
e	f	g	
21 $\pm$ 1.0	2.0 $\pm$ 0.5	2.0 $\pm$ 0.5	

### Direction of product insertion



[Packing : 3 000pcs/reel]

2. 750pcs/reel

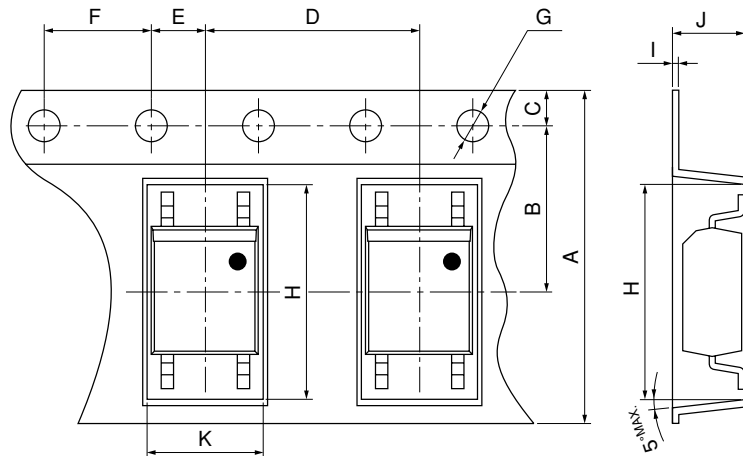
Package materials

Carrier tape : A-PET (with anti-static material)

Cover tape : PET (three layer system)

Reel : PS

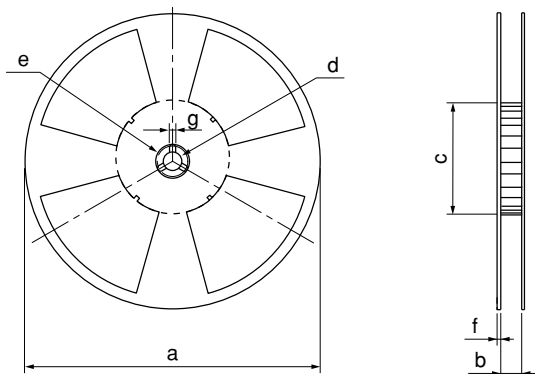
Carrier tape structure and Dimensions



Dimensions List (Unit : mm)

A	B	C	D	E	F	G
12.0 $\pm$ 0.3	5.5 $\pm$ 0.1	1.75 $\pm$ 0.1	8.0 $\pm$ 0.1	2.0 $\pm$ 0.1	4.0 $\pm$ 0.1	$\phi$ 1.5 $\pm$ 0.1
H	I	J	K			
7.4 $\pm$ 0.1	0.3 $\pm$ 0.05	3.1 $\pm$ 0.1	4.0 $\pm$ 0.1			

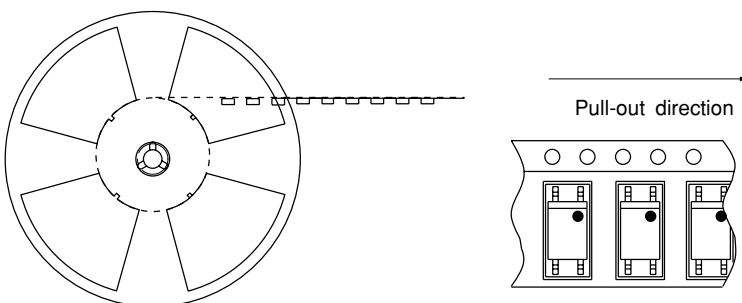
Reel structure and Dimensions



Dimensions List (Unit : mm)

a	b	c	d
180	13.5 $\pm$ 1.5	80 $\pm$ 1.0	13 $\pm$ 0.5
e	f	g	
21 $\pm$ 1.0	2.0 $\pm$ 0.5	2.0 $\pm$ 0.5	

Direction of product insertion



[Packing : 750pcs/reel]



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- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

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- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

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